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International **ISPR** Rectifier

POWER MOSFET THRU-HOLE (TO-257AA)

Product Summary

Part Number	RDS(on)	ID	Eyelets	
IRFY340	0.55 Ω	8.7A	Glass	
IRFY340M	0.55 Ω	8.7A	Glass	

HEXFET® MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.

Absolute Maximum Ratings

IRFY340, IRFY340M 400V, N-CHANNEL HEXFET[®] MOSFET TECHNOLOGY



Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- **Glass Eyelets**
- For Space Level Applications Refer to Ceramic Version Part Numbers IRFY340C, IRFY340CM

	Parameter		Units
ID @ VGS = 10V, TC = 25°C	Continuous Drain Current	8.7	Unito
ID @ VGS = 10V, TC = 100°C	Continuous Drain Current	5.5	A
IDM Pulsed Drain Current ①		35	
P _D @ T _C = 25°C	Max. Power Dissipation	100	W
	Linear Derating Factor	0.8	W/°C
VGS	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy 2	520	mJ
IAR	Avalanche Current ①	8.7	A
EAR	Repetitive Avalanche Energy ①	10	mJ
dv/dt	Peak Diode Recovery dv/dt 3	4.0	V/ns
ТJ	Operating Junction	-55 to 150	
TSTG	Storage Temperature Range		°C
	Lead Temperature	300(0.063in./1.6mm from case for 10 sec)	
	Weight	3.3 (Typical)	g

For footnotes refer to the last page

Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Tun	Max	Units	Test Conditions
			Тур	Wax		
BVDSS	Drain-to-Source Breakdown Voltage	400	—	—	V	$V_{GS} = 0V, I_D = 1.0mA$
∆BV _{DSS} /∆TJ	Temperature Coefficient of Breakdown Voltage		0.46	_	V/°C	Reference to 25°C, $I_D = 1.0$ mA
RDS(on)	Static Drain-to-Source On-State Resistance		-	0.55	Ω	VGS = 10V, ID = 5.5A ④
VGS(th)	Gate Threshold Voltage	2.0	_	4.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
9fs	Forward Transconductance	4.9	_	_	S (ひ)	V _{DS} > 15V, I _{DS} = 5.5A ④
IDSS	Zero Gate Voltage Drain Current		_	25		VDS= 320V ,VGS=0V
		_	—	250	μA	V _{DS} = 320V,
						$V_{GS} = 0V, T_{J} = 125^{\circ}C$
IGSS	Gate-to-Source Leakage Forward	_	—	100	nA	VGS = 20V
IGSS	Gate-to-Source Leakage Reverse		—	-100		V _{GS} = -20V
Qg	Total Gate Charge	_	_	65		V _{GS} =10V, I _D = 8.7A
Qgs	Gate-to-Source Charge	_	—	10	nC	$V_{DS} = 200V$
Q _{gd}	Gate-to-Drain ('Miller') Charge	_	—	40.5		
^t d(on)	Turn-On Delay Time	_	—	25		$V_{DD} = 200V, I_D = 8.7A,$
tr	Rise Time	_	—	92		R _G = 9.1Ω
^t d(off)	Turn-Off Delay Time	_	—	79	ns	
tf	FallTime	_	—	58		
Ls+LD	Total Inductance	_	6.8	—	nH	Measured from drain lead (6mm/0.25in. from
						package) to source lead (6mm/0.25in. from
						package)
C _{iss}	Input Capacitance		1400	—		$V_{GS} = 0V, V_{DS} = 25V$
C _{OSS}	Output Capacitance		350	—	pF	f = 1.0MHz
C _{rss}	Reverse Transfer Capacitance	—	230	_		

Source-Drain Diode Ratings and Characteristics

	Parameter		Min	Тур	Max	Units	Test Conditions
IS	Continuous Source Current ((Body Diode)			8.7	٨	
ISM	Pulse Source Current (Body Diode) ①				35	A	
VSD	Diode Forward Voltage		-	-	1.5	V	Tj = 25°C, IS = 8.7A, VGS = 0V ④
trr	Reverse Recovery Time				600	nS	Tj = 25°C, IF = 8.7A, di/dt ≤ 100A/μs
QRR	Reverse Recovery Charge		-		5.6	μC	$V_{DD} \le 50V $ (4)
ton	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $L_{S} + L_{D}$.					

Thermal Resistance

	Parameter	Min	Тур	Мах	Units	Test Conditions
RthJC	Junction-to-Case	—	—	1.25		
RthCS	Case-to-sink	—	0.21	_	°C/W	
R _{th} JA	Junction-to-Ambient	—	—	80		Typical socket mount

Note: Corresponding Spice and Saber models are available on the G&S Website.

For footnotes refer to the last page

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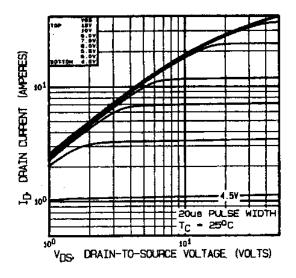


Fig 1. Typical Output Characteristics

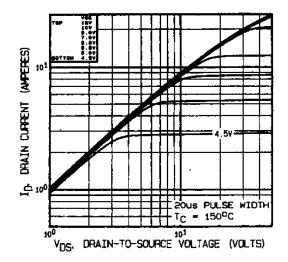


Fig 2. Typical Output Characteristics

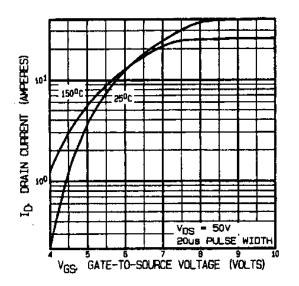
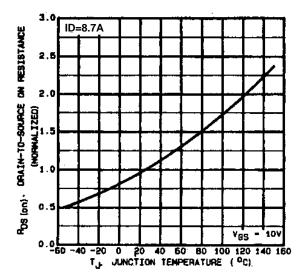
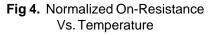


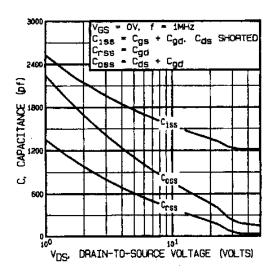
Fig 3. Typical Transfer Characteristics



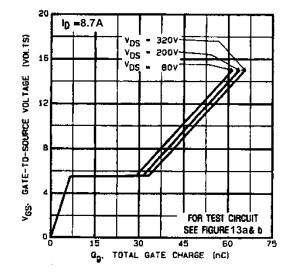


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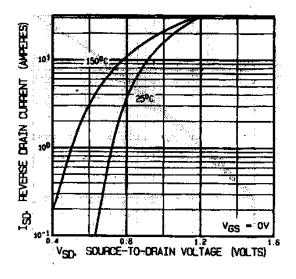


Fig 7. Typical Source-Drain Diode Forward Voltage

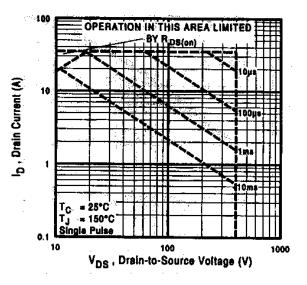
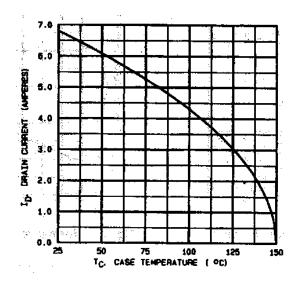


Fig 8. Maximum Safe Operating Area

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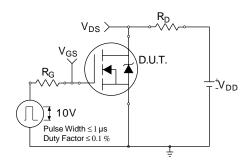


Fig 10a. Switching Time Test Circuit

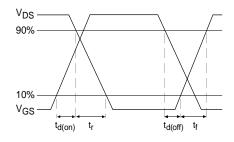


Fig 10b. Switching Time Waveforms

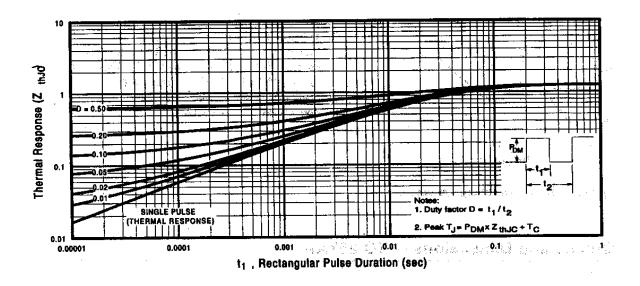


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

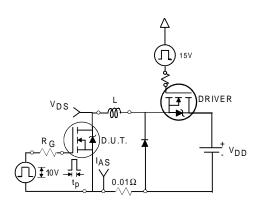


Fig 12a. Unclamped Inductive Test Circuit

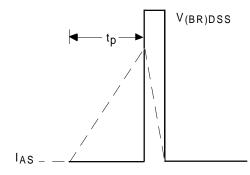


Fig 12b. Unclamped Inductive Waveforms

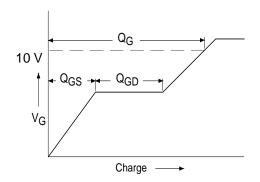


Fig 13a. Basic Gate Charge Waveform

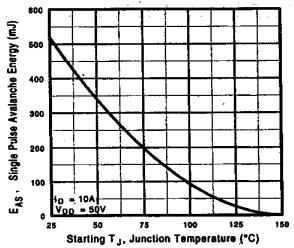


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

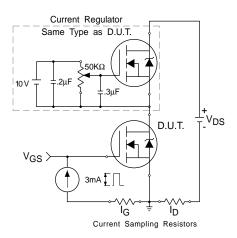


Fig 13b. Gate Charge Test Circuit

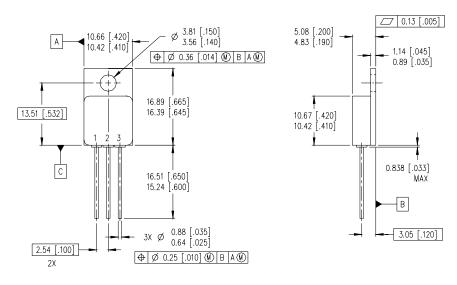
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Footnotes:

- Repetitive Rating; Pulse width limited by maximum junction temperature.
- 2 VDD = 50V, starting TJ = 25°C, L= 13mH Peak IL = 8.7A, VGS = 10V

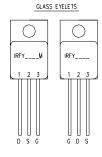
- $\label{eq:ISD} \begin{array}{ll} & I_{SD} \leq 8.7 \text{A}, \mbox{ di/dt} \leq 120 \text{A}/\mu \text{s}, \\ & V_{DD} \leq 400 \text{V}, \mbox{ T}_J \leq 150 \mbox{°C} \end{array}$
- ④ Pulse width \leq 300 µs; Duty Cycle \leq 2%

Case Outline and Dimensions - TO-257AA



NOTES:

- 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA.
- <u>LEGEND</u> D – DRAIN S – SOURCE
- G GATE



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